

S3C6410 OpenGLES User's Guide

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S3C6410 RISC Microprocessor FIMG-3D User's Guide

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Revision History

Revision No	Description of Change	Refer to	Author(s)	Date
1.0	Initial Draft		JeGeon Jung	2009-01-05
1.1.0	Driver structure is modified		JeGeon Jung	2009-02-06

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오류! 그림 목차 항목을 찾을 수 없습니다.



1 Introduction

1.1 Purpose

This document is prepared for the purpose of describing the 6410 OpenGLES usage guide.

1.2 Scope

The scope of this document is to describe

How to use library.

1.3 Intended Audience

Intended Audience	Tick whenever Applicable
Project Manager	Yes
Project Leader	Yes
Project Team Member	Yes
Test Engineer	Yes

1.4 Supported HW & SW

Intended Audience	Tick whenever Applicable
HW	Samsung S3C6410 FIMG-3D
OS	Microsoft Windows CE 6.0

1.5 Definitions, Acronyms, and Abbreviations

Abbreviations	Description

1.6 References

Number	Reference	Description
1	S3C6410 Datasheet	S3C6410 Datasheet



1

2 Structure

2.1 Software layers

please visit www.opengl.org website.

OpenGLES driver has two layers. One is for mapping H/W and allocating memory. Another one is for OpenGLES Libraries.

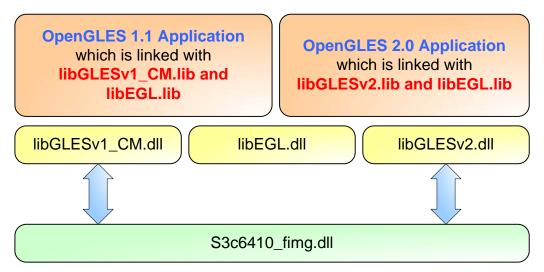


Figure 1 S3C6410 OpenGLES Software layer

The Figure 1 shows this driver structure. S3c6410_fimg.dll is mapping and allocating layer. This driver maps H/W address for library. The library uses this mapped address. And it also allocates physically continous memory for library and FIMG H/W. If the library request some texture memory and depth buffer, then this driver dynamically allocates some memory and return the address. The libEGL.lib implements EGL 1.3. This will work with OpenGLES1.1 and OpenGLES2.0 The libGLESv1_CM.dll implements OpenGLES1.1. If you want to know more about OpenGLES 1.1,

The libGLESv2.dll implements OpenGLES2.0. If you want to know more about OpenGLES 1.1, please visit www.opengl.org website.



3 Build guide

3.1 Libraries

There are libraries for building application.

Library File	Description
libGLESv1_CM.lib	OpenGLES 1.1 library
libGLESv2.lib	OpenGLES 2.0 library
libEGL.lib	EGL 1.3 library

3.2 Header files

There are include folder.

File Name	Description
EGL/egl.h	EGL Header file
GLES2/gl2.h	OpenGLES 2.0 Header file
GLES/gl.h	OpenGLES 1.1 Header file

You don't need to care about other files.

3.3 Usage

For using OpenGLES, You need to link EGL and OpenGLES libraries. In Project property of Visual Studio 2005, set Additional Dependency like the following Figure 2.

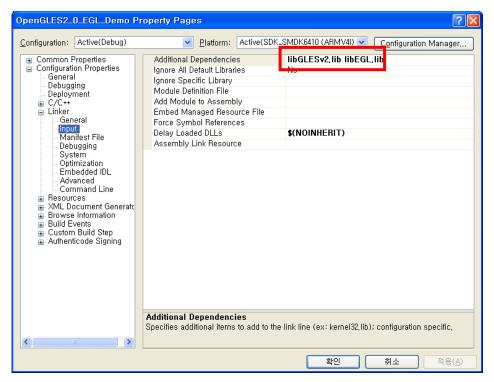


Figure 2 Setting Property for OpenGLES2.0 in VS2005

If you need to use OpenGLES 1.1, then you need to input libGLESv1_CM.lib instead of libGLESv2.lib.



3.4 Shader Compile

You need to use orion compiler for compiling shader. You can execute attached compiler on MS Windows XP and VISTA.

Ex) orion -O -f <Fragment Shader File> orion -O -v <Vertex Shader File> orion -O -a -f <Fragment Shader ASM File> orion -O -a -v <Fragment Shader ASM File>

If you type just "orion", you can see more detail information about this shader compiler.



4 Execution guide

4.1 DII location

libEGL.dll, libGLESv1_CM.dll and libGLESv2.dll should be in \Windows directory or same directory with your application. Second has higher priority.



5 Samples

5.1 OpenGLES 1.1 Demo Application

The location is (samples\OPENGLES\OpenGLES1_1_EGL_Demo) Very simple opengles demo. You can get example about OpenGLES application and compile environment from source code.

You can modify line 80 "int selectedDemo" from 0 to 7.

5.2 OpenGLES 2.0 Demo Application

The location is (samples\OPENGLES\OpenGLES2_0_EGL_Demo) Very simple opengles demo. You can get example about OpenGLES application and compile environment from source code.

You can modify line 59 "int selectedDemo" from 0 to 2.

